

PCF8564A

Real time clock and calendar Rev. 3 — 26 August 2013

Product data sheet

General description 1.

The PCF8564A is a CMOS¹ real-time clock and calendar optimized for low power consumption. A programmable clock output, interrupt output and voltage low detector are also provided. All addresses and data are transferred serially via the two-line bidirectional I²C-bus. Maximum bus speed is 400 kbit/s. The built-in word address register is incremented automatically after each written or read data byte.

Features and benefits 2.

- Provides year, month, day, weekday, hours, minutes, and seconds based on a 32.768 kHz quartz crystal
- Wide clock operating voltage: 1.0 V to 5.5 V
- Low back-up current typical 250 nA at 3.0 V and 25 °C
- 400 kHz two-wire I²C interface (1.8 V to 5.5 V)
- Low-voltage detector
- Alarm and timer functions
- Two integrated oscillator capacitors
- Programmable clock output for peripheral devices (32.768 kHz, 1.024 kHz, 32 Hz, and 1 Hz)
- Internal Power-On Reset (POR)
- I²C slave address: read A3h, write A2h

Applications

- Timing devices
 - Time of the day tracking
 - Process timing
 - Alarm
- Portable instruments
- Electronic metering
- Battery powered products

The definition of the abbreviations and acronyms used in this data sheet can be found in Section 20.



Real time clock and calendar

4. Ordering information

Table 1. Ordering information

| Type number | Package | | |
|-------------|----------|-------------------------------|------------|
| | Name | Description | Version |
| PCF8564AU | bare die | wire bond die; 9 bonding pads | PCF8564AU |
| PCF8564AUG | bare die | 9 bumps | PCF8564AUG |

4.1 Ordering options

Table 2. Ordering options

| Product type number | Sales item (12NC) | Orderable part number | IC revision | Delivery form |
|---------------------|-------------------|-----------------------|----------------|--|
| PCF8564AU/10AB/1 | 935289478005 | PCF8564AU/10AB/1,0 | 1 | wafer, sawn, on FFC |
| PCF8564AU/5BB/1 | 935289319015 | PCF8564AU/5BB/1,01 | 1 | unsawn wafer |
| PCF8564AU/5GB/1 | 935289477015 | PCF8564AU/5GB/1,01 | 1 | unsawn wafer |
| PCF8564AU/5GC/1 | 935293569015 | PCF8564AU/5GC/1,01 | 1 | unsawn wafer |
| PCF8564AUG/12HB/1 | 935301011005 | PCF8564AUG/12HB/1V | 1 | wafer, sawn, on 8 inch metal FFC; chips with soft bumps[1] |

^[1] Bump hardness, see <u>Table 36</u>.

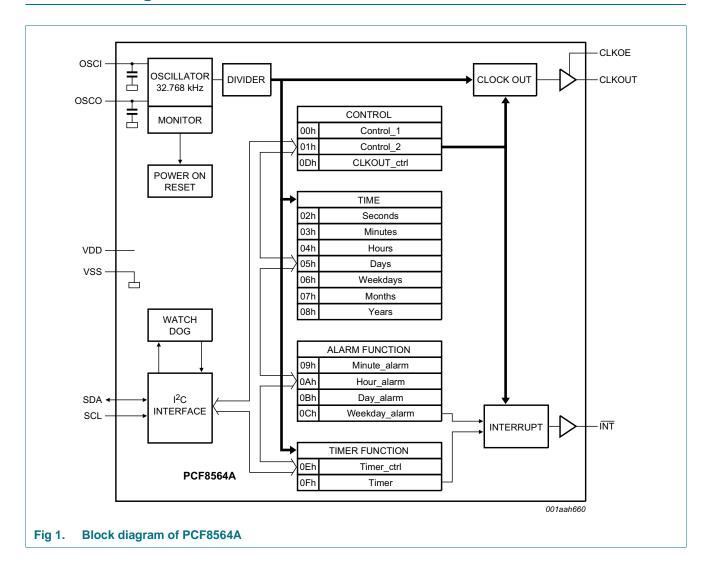
5. Marking

Table 3. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PCF8564AU | PC8564A-1 |
| PCF8564AUG | PC8564A-1 |

Real time clock and calendar

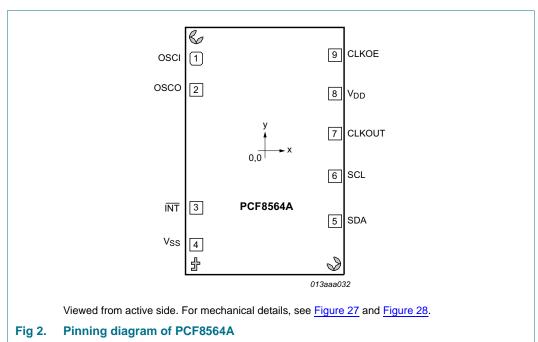
6. Block diagram



Real time clock and calendar

7. Pinning information

7.1 Pinning



Pin description

7.2 Pin description

Table 4.

Input or input/output pins must always be at a defined level (V_{SS} or V_{DD}) unless otherwise specified.

| , , , | • | , (65 55) |
|-----------------|-----|--|
| Symbol | Pin | Description |
| OSCI | 1 | oscillator input |
| OSCO | 2 | oscillator output |
| INT | 3 | interrupt output, open-drain, active LOW |
| V _{SS} | 4 | ground ^[1] |
| SDA | 5 | serial data input and output |
| SCL | 6 | serial clock input |
| CLKOUT | 7 | clock output, push-pull |
| V_{DD} | 8 | supply voltage |
| CLKOE | 9 | CLKOUT enable input |
| | | |

^[1] The substrate (rear side of the die) is at $V_{\mbox{\footnotesize{SS}}}$ potential and must not be connected.

Real time clock and calendar

8. Functional description

The PCF8564A contains sixteen 8-bit registers with an auto-incrementing address register, an on-chip 32.768 kHz oscillator with integrated capacitors, a frequency divider which provides the source clock for the RTC, a programmable clock output, a timer, a voltage low detector, and a 400 kHz I²C-bus interface.

All sixteen registers (see <u>Table 5</u>) are designed as addressable 8-bit parallel registers although not all bits are implemented. The first two registers (memory address 00h and 01h) are used as control and/or status registers. The addresses 02h through 08h are used as counters for the clock function (seconds up to years counters). Address locations 09h through 0Ch contain alarm registers which define the conditions for an alarm. Address 0Dh controls the CLKOUT output frequency. 0Eh and 0Fh are the timer control and timer registers, respectively.

The seconds, minutes, hours, days, months, years, as well as the minute alarm, hour alarm, and day alarm registers are all coded in BCD format.

8.1 CLKOUT output

A programmable square wave is available at the CLKOUT pin. Frequencies of 32.768 kHz, 1.024 kHz, 32 Hz and 1 Hz can be generated for use as a system clock, microcontroller clock, input to a charge pump, or for calibration of the oscillator. CLKOUT is a CMOS push-pull output, and if disabled it becomes logic 0.

Real time clock and calendar

8.2 Register organization

Table 5. Register overview

Bit positions labelled as - are not implemented. Bit positions labelled as N should always be written with logic 0. After reset, all registers are set according to <u>Table 28</u>.

| Address | Register name | Bit | | | | | | | |
|------------|-----------------|------------------|-------------------|-----------------|-------------|-----------|-------|---------|-----|
| | | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Control re | gisters | ' | | | ' | ' | ' | ' | ' |
| 00h | Control_1 | TEST1 | N | STOP | N | TESTC | N | N | N |
| 01h | Control_2 | N | N | N | TI_TP | AF | TF | AIE | TIE |
| Time and | date registers | 1 | | | <u> </u> | | | | 1 |
| 02h | Seconds | Seconds VL SECON | | | | | | | |
| 03h | Minutes | - | MINUTES (0 to 59) | | | | | | |
| 04h | Hours | - | - | HOURS (0 to 23) | | | | | |
| 05h | Days | - | - | DAYS (1 | to 31) | | | | |
| 06h | Weekdays | - | - | - | - | - | WEEKD | AYS | |
| 07h | Months | С | - | - | MONTH | (1 to 12) | | | |
| 08h | Years | YEARS (|) to 99) | | ' | | | | |
| Alarm regi | sters | | | | | | | | |
| 09h | Minute_alarm | AEN_M | MINUTE | _ALARM (0 | to 59) | | | | |
| 0Ah | Hour_alarm | AEN_H | - | HOUR_A | LARM (0 to | 23) | | | |
| 0Bh | Day_alarm | AEN_D | - | DAY_ALA | ARM (1 to 3 | 51) | | | |
| 0Ch | Weekday_alarm | AEN_W | - | - | - | - | WEEKD | AY_ALAR | М |
| CLKOUT o | ontrol register | 1 | 1 | | | ' | | | |
| 0Dh | CLKOUT_ctrl | FE | - | - | - | - | - | FD[1:0] | |
| Timer regi | sters | 1 | 1 | | | ' | | | |
| 0Eh | Timer_ctrl | TE | - | - | - | - | - | TD[1:0] | |
| 0Fh | Timer | TV[7:0] | | | 1 | 1 | 1 | 1 | |

Real time clock and calendar

8.3 Control registers

8.3.1 Register Control_1

Table 6. Control_1 - control and status register 1 (address 00h) bit description

| Bit | Symbol | Value | Description | Reference |
|--------|--------|--------|---|----------------|
| 7 | TEST1 | 0[1] | normal mode; | Section 8.9 |
| | | | must be set to logic 0 during normal operations | |
| | | 1 | EXT_CLK test mode (see Section 8.9) | |
| 6 | N | 0[2] | default value | |
| 5 | STOP | 0[1] | RTC source clock runs | Section 8.10 |
| | | | RTC divider chain flip-flops are asynchronously set to logic 0 | |
| | | | • the RTC clock is stopped (CLKOUT at 32.768 kHz is still available) | |
| 4 | N | 0[2] | default value | |
| 3 | TESTC | 0 | Power-On Reset (POR) override facility is disabled; | Section 8.11.1 |
| | | | set to logic 0 for normal operation (see <u>Section 8.11.1</u>) | |
| | | 1[1] | Power-On Reset (POR) override is enabled | |
| 2 to 0 | N | 000[2] | default value | |

^[1] Default value.

8.3.2 Register Control_2

Table 7. Control_2 - control and status register 2 (address 01h) bit description

| Bit | Symbol | Value | Description | Reference |
|--------|--------|--------|--|-----------------|
| 7 to 5 | N | 000[1] | default value | |
| 4 | TI_TP | 0[2] | INT is active when TF is active (subject to the status of TIE) | |
| | | 1 | INT pulses active according to <a>Table 8 (subject to the status of TIE); | Section 8.3.2.1 |
| | | | Remark: note that if AF and AIE are active then INT will be permanently active | and Section 8.8 |
| 3 | AF | 0[2] | alarm flag inactive | Section 8.3.2.1 |
| | | 1 | alarm flag active | |
| 2 | TF | 0[2] | timer flag inactive | Section 8.3.2.1 |
| | | 1 | timer flag active | |
| 1 | AIE | 0[2] | alarm interrupt disabled | Section 8.3.2.1 |
| | | 1 | alarm interrupt enabled | |
| 0 | TIE | 0[2] | timer interrupt disabled | Section 8.3.2.1 |
| | | 1 | timer interrupt enabled | |

^[1] Bits labeled as N should always be written with logic 0.

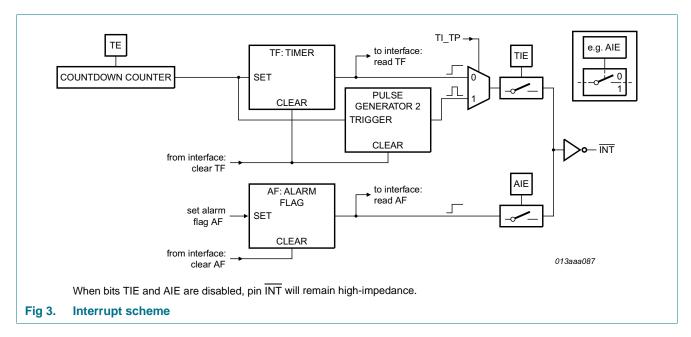
^[2] Bits labeled as N should always be written with logic 0.

^[2] Default value.

Real time clock and calendar

8.3.2.1 Interrupt output

Bits TF and AF: When an alarm occurs, AF is set to 1. Similarly, at the end of a timer countdown, TF is set to 1. These bits maintain their value until overwritten by command. If both timer and alarm interrupts are required in the application, the source of the interrupt can be determined by reading these bits. To prevent one flag being overwritten while clearing another, a logic AND is performed during a write access.



Bits TIE and AIE: These bits activate or deactivate the generation of an interrupt when TF or AF is asserted respectively. The interrupt is the logical OR of these two conditions when both AIE and TIE are set.

Countdown timer interrupts: The pulse generator for the countdown timer interrupt uses an internal clock and is dependent on the selected source clock for the countdown timer and on the countdown value TV. As a consequence, the width of the interrupt pulse varies (see Table 8).

Table 8. INT operation (bit TI TP = 1)[1]

| Source clock (Hz) | INT period (s) | | | | |
|-------------------|-------------------------------|--------|--|--|--|
| | TV = 1[2] | TV > 1 | | | |
| 4096 | 1/8192 | 1/4096 | | | |
| 64 | ¹ / ₁₂₈ | 1/64 | | | |
| 1 | 1/64 | 1/64 | | | |
| 1/60 | 1/64 | 1/64 | | | |

^[1] TF and $\overline{\text{INT}}$ become active simultaneously.

^[2] TV = loaded countdown value. Timer is stopped when TV = 0.

Real time clock and calendar

8.4 Time and date registers

The majority of the registers are coded in the BCD format to simplify application use.

8.4.1 Register Seconds

Table 9. Seconds - seconds and clock integrity status register (address 02h) bit description

| Bit | Symbol | Value | Place value | Description |
|--------|---------|--------|-------------|---|
| 7 | VL | 0 | - | clock integrity is guaranteed |
| | | 1[1] | - | integrity of the clock information is not guaranteed |
| 6 to 4 | SECONDS | 0 to 5 | ten's place | actual seconds coded in BCD format, see <u>Table 10</u> |
| 3 to 0 | | 0 to 9 | unit place | |

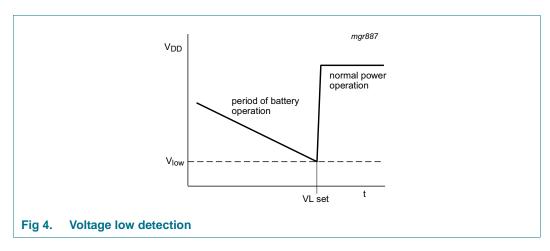
^[1] Start-up value.

Table 10. Seconds coded in BCD format

| Seconds value in decimal | Upper-dig | git (ten's p | lace) | Digit (unit place) | | | |
|--------------------------|-----------|--------------|-------|--------------------|-------|-------|-------|
| | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
| 00 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 01 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| 02 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| : | | | | | | | |
| 09 | 0 | 0 | 0 | 1 | 0 | 0 | 1 |
| 10 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| : | | | | | | | |
| 58 | 1 | 0 | 1 | 1 | 0 | 0 | 0 |
| 59 | 1 | 0 | 1 | 1 | 0 | 0 | 1 |

8.4.1.1 Voltage low detector and clock monitor

The PCF8564A has an on-chip voltage low detector. When V_{DD} drops below V_{low} the VL (Voltage Low) flag is set to indicate that the integrity of the clock information is no longer guaranteed. The VL flag can only be cleared by command.



Real time clock and calendar

The VL flag is intended to detect the situation when V_{DD} is decreasing slowly, for example under battery operation. Should the oscillator stop or V_{DD} reach V_{low} before power is re-asserted, then the VL flag will be set. This indicates that the time is possibly corrupted.

8.4.2 Register Minutes

Table 11. Minutes - minutes register (address 03h) bit description

| Bit | Symbol | Value | Place value | Description |
|--------|---------|--------|-------------|------------------------------------|
| 7 | - | - | - | unused |
| 6 to 4 | MINUTES | 0 to 5 | ten's place | actual minutes coded in BCD format |
| 3 to 0 | | 0 to 9 | unit place | |

8.4.3 Register Hours

Table 12. Hours - hours register (address 04h) bit description

| Bit | Symbol | Value | Place value | Description |
|--------|--------|--------|-------------|----------------------------------|
| 7 to 6 | - | - | - | unused |
| 5 to 4 | HOURS | 0 to 2 | ten's place | actual hours coded in BCD format |
| 3 to 0 | | 0 to 9 | unit place | |

8.4.4 Register Days

Table 13. Days - days register (address 05h) bit description

| Bit | Symbol | Value | Place value | Description |
|--------|---------|--------|-------------|--------------------------------|
| 7 to 6 | - | - | - | unused |
| 5 to 4 | DAYS[1] | 0 to 3 | ten's place | actual day coded in BCD format |
| 3 to 0 | | 0 to 9 | unit place | |

^[1] The PCF8564A compensates for leap years by adding a 29th day to February if the year counter contains a value which is exactly divisible by 4, including the year 00.

8.4.5 Register Weekdays

Table 14. Weekdays - weekdays register (address 06h) bit description

| Bit | Symbol | Value | Description |
|--------|----------|--------|-------------------------------------|
| 7 to 3 | - | - | unused |
| 2 to 0 | WEEKDAYS | 0 to 6 | actual weekday values, see Table 15 |

Real time clock and calendar

Table 15. Weekday assignments

| Day[1] | Bit | | | | |
|-----------|-----|---|---|--|--|
| | 2 | 1 | 0 | | |
| Sunday | 0 | 0 | 0 | | |
| Monday | 0 | 0 | 1 | | |
| Tuesday | 0 | 1 | 0 | | |
| Wednesday | 0 | 1 | 1 | | |
| Thursday | 1 | 0 | 0 | | |
| Friday | 1 | 0 | 1 | | |
| Saturday | 1 | 1 | 0 | | |

^[1] Definition may be re-assigned by the user.

8.4.6 Register Months

Table 16. Months - months and century flag register (address 07h) bit description

| Bit | Symbol | Value | Place value | Description |
|--------|--------|--------|-------------|--|
| 7 | C[1] | 0[2] | - | indicates the century is x |
| | | 1 | - | indicates the century is x + 1 |
| 6 to 5 | - | - | - | unused |
| 4 | MONTHS | 0 to 1 | ten's place | actual month coded in BCD format, see Table 17 |
| 3 to 0 | | 0 to 9 | unit place | |

^[1] This bit may be re-assigned by the user.

Table 17. Month assignments coded in BCD format

| Month | Upper-digit (ten's place) | Digit (unit place) | | | | |
|-----------|---------------------------|--------------------|-------|-------|-------|--|
| | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | |
| January | 0 | 0 | 0 | 0 | 1 | |
| February | 0 | 0 | 0 | 1 | 0 | |
| March | 0 | 0 | 0 | 1 | 1 | |
| April | 0 | 0 | 1 | 0 | 0 | |
| May | 0 | 0 | 1 | 0 | 1 | |
| June | 0 | 0 | 1 | 1 | 0 | |
| July | 0 | 0 | 1 | 1 | 1 | |
| August | 0 | 1 | 0 | 0 | 0 | |
| September | 0 | 1 | 0 | 0 | 1 | |
| October | 1 | 0 | 0 | 0 | 0 | |
| November | 1 | 0 | 0 | 0 | 1 | |
| December | 1 | 0 | 0 | 1 | 0 | |

^[2] This bit is toggled when the register Years overflows from 99 to 00.

Real time clock and calendar

8.4.7 Register Years

Table 18. Years - years register (08h) bit description

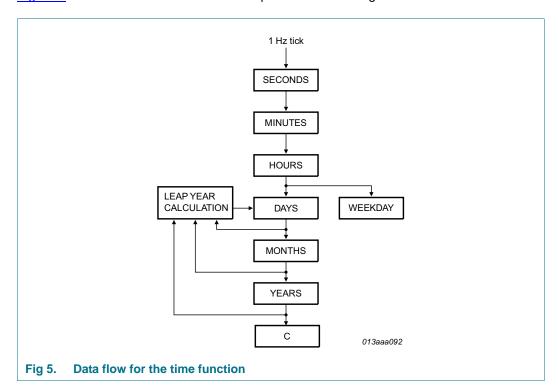
| Bit | Symbol | Value | Place value | Description |
|--------|--------|--------|-------------|------------------------------------|
| 7 to 4 | YEARS | 0 to 9 | ten's place | actual year coded in BCD format[1] |
| 3 to 0 | _ | 0 to 9 | unit place | - |

^[1] When the register Years overflows from 99 to 00, the century bit C in the register Months is toggled.

The PCF8564A compensates for leap years by adding a 29th day to February if the year counter contains a value which is divisible by 4, including the year 00.

8.5 Setting and reading the time

Figure 5 shows the data flow and data dependencies starting from the 1 Hz clock tick.



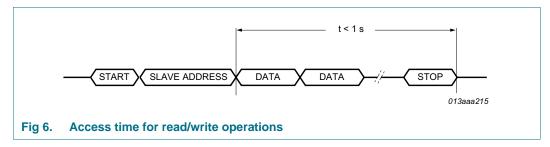
During read/write operations, the time counting circuits (memory locations 02h through 08h) are blocked.

This prevents

- Faulty writing or reading of the clock and calendar during a carry condition
- Incrementing the time registers, during the read cycle

After this read/write access is completed, the time circuit is released again and any pending request to increment the time counters, that occurred during the read access, is serviced. A maximum of 1 request can be stored; therefore, all accesses must be completed within 1 second (see Figure 6).

Real time clock and calendar



As a consequence of this method, it is very important to make a read or write access in one go, that is, setting or reading seconds through to years should be made in one single access. Failing to comply with this method could result in the time becoming corrupted.

As an example, if the time (seconds through to hours) is set in one access and then in a second access the date is set, it is possible that the time may increment between the two accesses. A similar problem exists when reading. A roll over may occur between reads thus giving the minutes from one moment and the hours from the next.

Recommended method for reading the time:

- 1. Send a START condition and the slave address for write (A2h).
- 2. Set the address pointer to 2 (seconds) by sending 02h.
- 3. Send a RE-START condition or STOP followed by START.
- 4. Send the slave address for read (A3h).
- 5. Read the seconds.
- 6. Read the minutes.
- 7. Read the hours.
- 8. Read the days.
- 9. Read the weekdays.
- 10. Read the century and month.
- 11. Read the years.
- 12. Send a STOP condition.

8.6 Alarm registers

8.6.1 Register Minute_alarm

Table 19. Minute_alarm - minute alarm register (address 09h) bit description

| Bit | Symbol | Value | Place value | Description |
|--------|--------------|--------|-------------|---------------------------------------|
| 7 | AEN_M | 0 | - | minute alarm is enabled |
| | | 1[1] | - | minute alarm is disabled |
| 6 to 4 | MINUTE_ALARM | 0 to 5 | ten's place | minute alarm information coded in BCD |
| 3 to 0 | | 0 to 9 | unit place | format |

[1] Default value.

Real time clock and calendar

8.6.2 Register Hour_alarm

Table 20. Hour_alarm - hour alarm register (address 0Ah) bit description

| Bit | Symbol | Value | Place value | Description |
|--------|------------|--------|-------------|-------------------------------------|
| 7 | AEN_H | 0 | - | hour alarm is enabled |
| | | 1[1] | - | hour alarm is disabled |
| 6 | - | - | - | unused |
| 5 to 4 | HOUR_ALARM | 0 to 2 | ten's place | hour alarm information coded in BCD |
| 3 to 0 | | 0 to 9 | unit place | format |

^[1] Default value.

8.6.3 Register Day_alarm

Table 21. Day_alarm - day alarm register (address 0Bh) bit description

| Bit | Symbol | Value | Place value | Description |
|--------|-----------|--------|-------------|------------------------------------|
| 7 | AEN_D | 0 | - | day alarm is enabled |
| | | 1[1] | - | day alarm is disabled |
| 6 | - | - | - | unused |
| 5 to 4 | DAY_ALARM | 0 to 3 | ten's place | day alarm information coded in BCD |
| 3 to 0 | | 0 to 9 | unit place | format |

^[1] Default value.

8.6.4 Register Weekday_alarm

Table 22. Weekday_alarm - weekday alarm register (address 0Ch) bit description

| Bit | Symbol | Value | Description |
|--------|---------------|--------|---|
| 7 | AEN_W | 0 | weekday alarm is enabled |
| | | 1[1] | weekday alarm is disabled |
| 6 to 3 | - | - | unused |
| 2 to 0 | WEEKDAY_ALARM | 0 to 6 | weekday alarm information coded in BCD format |
| | | | |

^[1] Default value.

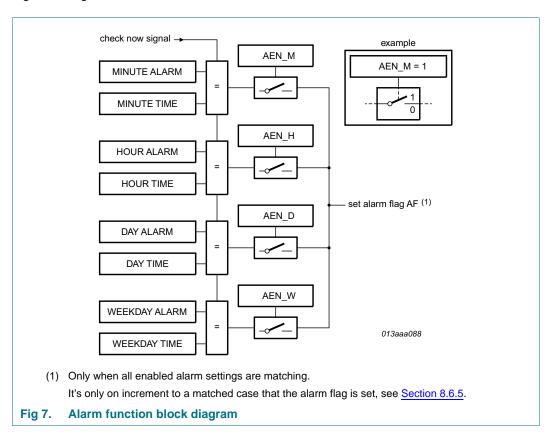
8.6.5 Alarm flag

By clearing the MSB of one or more of the alarm registers AEN_x (Alarm Enable), the corresponding alarm condition(s) are active. When an alarm occurs, AF is set to logic 1. The asserted AF can be used to generate an interrupt (INT). The AF is cleared by command.

The registers at addresses 09h through 0Ch contain alarm information. When one or more of these registers is loaded with a valid minute, hour, day, or weekday and its corresponding Alarm Enable bit (AEN_x) is logic 0, then that information is compared with the current minute, hour, day, and weekday. When all enabled comparisons first match, the Alarm Flag (AF in register Control_2) is set to logic 1.

Real time clock and calendar

The generation of interrupts from the alarm function is controlled via bit AIE. If bit AIE is enabled, the INT pin follows the condition of bit AF. AF will remain set until cleared by command. Once AF has been cleared, it will only be set again when the time increments to match the alarm condition once more. Alarm registers which have their AEN_x bit at logic 1 are ignored.



8.7 Register CLKOUT_ctrl and clock output

A programmable square wave is available at pin CLKOUT. Operation is controlled by the FE bit in register CLKOUT_ctrl at address 0Dh and the CLKOUT output enable pin (CLKOE). To enable pin CLKOUT pin CLKOE must be set HIGH.

Frequencies of 32.768 kHz (default), 1.024 kHz, 32 Hz, and 1 Hz can be generated for use as a system clock, microcontroller clock, input to a charge pump, or for calibration of the oscillator.

Real time clock and calendar

Table 23. CLKOUT_ctrl - CLKOUT control register (address 0Dh) bit description

| | | 5 |
|---------|--------------|--|
| Symbol | Value | Description |
| FE | 0 | the CLKOUT output is inhibited and CLKOUT output is set to logic 0 |
| | 1 <u>[1]</u> | the CLKOUT output is activated |
| - | - | unused |
| FD[1:0] | | frequency output at pin CLKOUT |
| | 00[1] | 32.768 kHz |
| | 01 | 1.024 kHz |
| | 10 | 32 Hz |
| | 11 | 1 Hz |
| | | FE 0 1[1] FD[1:0] 00[1] 01 10 |

^[1] Default value.

8.8 Timer function

The 8-bit countdown timer at address 0Fh is controlled by the timer control register at address 0Eh. The timer control register determines one of 4 source clock frequencies for the timer (4.096 kHz, 64 Hz, 1 Hz, or $\frac{1}{60}$ Hz) and enables or disables the timer. The timer counts down from a software-loaded 8-bit binary value. At the end of every countdown, the timer sets the TF (Timer Flag) to logic 1. The TF may only be cleared using the interface.

The generation of interrupts from the timer function is controlled via bit TIE. If bit TIE is enabled the $\overline{\text{INT}}$ pin follows the condition of bit TF. The interrupt may be generated as a pulsed signal every countdown period or as a permanently active signal which follows the condition of the timer flag TF. TI_TP is used for this mode control. When reading the timer, the current countdown value is returned.

8.8.1 Register Timer_ctrl

Table 24. Timer_ctrl - timer control register (address 0Eh) bit description

| Bit | Symbol | Value | Description |
|----------------|--------|-------------------|--|
| 7 TE | | 0[1] | timer is disabled |
| | | 1 | timer is enabled |
| 6 to 2 | - | - | unused |
| 1 to 0 TD[1:0] | | | timer source clock frequency select[2] |
| | | 00 | 4.096 kHz |
| | | 01 | 64 Hz |
| | | 10 | 1 Hz |
| | | 11 ^[2] | ¹⁄ ₆₀ Hz |

^[1] Default value.

^[2] These bits determine the source clock for the countdown timer; when not in use, TD[1:0] should be set to $\frac{1}{60}$ Hz for power saving.

Real time clock and calendar

8.8.2 Register Timer

Table 25. Timer - timer register (address 0Fh) bit description

| Bit | Symbol | Value | Description |
|--------|---------|-----------|--------------------------|
| 7 to 0 | TV[7:0] | 0h to FFh | countdown timer value[1] |

[1] Countdown period in seconds: $CountdownPeriod = \frac{TV}{SourceClockFrequency}$ where TV is the countdown timer value.

Table 26. Timer register bits value range

| Bit | | | | | | | |
|-----|----|----|----|---|---|---|---|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 128 | 64 | 32 | 16 | 8 | 4 | 2 | 1 |

The timer register is an 8-bit binary countdown timer. It is enabled or disabled via the timer control register. The source clock for the timer is also selected by the timer control register. Other timer properties such as single or periodic interrupt generation are controlled via the register Control_2 (address 01h).

For accurate read back of the count down value, the I²C-bus clock (SDA) must be operating at a frequency of at least twice the selected timer clock. Since it is not possible to freeze the countdown timer counter during read back, it is recommended to read the register twice and check for consistent results.

8.9 EXT CLK test mode

The test mode is entered by setting the TEST1 bit of register Control_1 to logic 1. The CLKOUT pin then becomes an input. The test mode replaces the internal 64 Hz signal with that applied to the CLKOUT pin. Every 64 positive edges applied to CLKOUT then generates an increment of one second.

The signal applied to the CLKOUT pin should have a minimum pulse width of 300 ns and a maximum period of 1000 ns. The 64 Hz clock, now sourced from CLKOUT, is divided down to 1 Hz by a 2⁶ divide chain called a prescaler. The prescaler can be set to a known state by using the STOP bit. When the STOP bit is set, the prescaler is reset to logic 0. (STOP must be cleared before the prescaler can operate.)

From a STOP condition, the first 1 second increment will take place after 32 positive edges on CLKOUT. Thereafter, every 64 positive edges will cause a 1 second increment.

Remark: Entry into EXT_CLK test mode is not synchronized to the internal 64 Hz clock. When entering the test mode, no assumption as to the state of the prescaler can be made.

8.9.1 Operation example

- 1. Set EXT_CLK test mode (Bit 7 Control_1 = 1).
- 2. Set STOP (Bit 5 Control_1 = 1).
- 3. Clear STOP (Bit 5 Control_1 = 0).
- 4. Set time registers to desired value.
- 5. Apply 32 clock pulses to CLKOUT.

PCF8564A

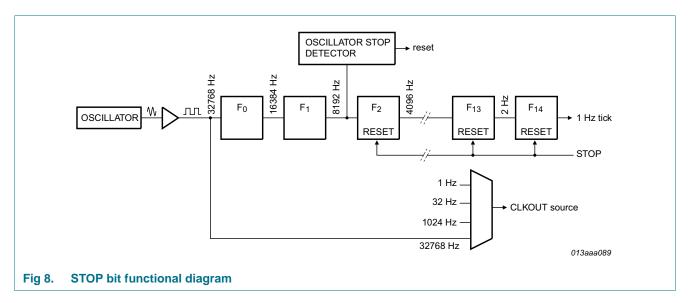
Real time clock and calendar

- 6. Read time registers to see the first change.
- 7. Apply 64 clock pulses to CLKOUT.
- 8. Read time registers to see the second change.

Repeat 7 and 8 for additional increments.

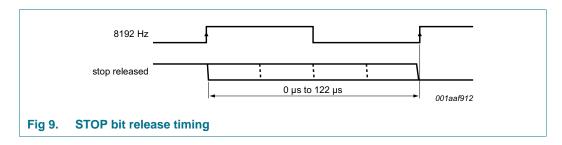
8.10 STOP bit function

The function of the STOP bit is to allow for accurate starting of the time circuits. The STOP bit function will cause the upper part of the prescaler (F_2 to F_{14}) to be held in reset and thus no 1 Hz ticks will be generated (see <u>Figure 8</u>). The time circuits can then be set and will not increment until the STOP bit is released (see <u>Figure 9</u> and <u>Table 27</u>).



The STOP bit function will not affect the output of 32.768 kHz on CLKOUT, but will stop the generation of 1.024 kHz, 32 Hz and 1 Hz.

The lower two stages of the prescaler (F_0 and F_1) are not reset and because the I²C-bus is asynchronous to the crystal oscillator, the accuracy of re-starting the time circuits will be between zero and one 8.192 kHz cycle (see Figure 9).



Real time clock and calendar

Table 27. First increment of time circuits after STOP bit release

| Bit | Prescaler bits | <u>[1]</u> | 1 Hz tick | Time | Comment |
|----------|--|---------------------------------|---|-----------------|---|
| STOP | F ₀ F ₁ -F ₂ to F ₁₄ | | | hh:mm:ss | |
| Clock is | running normally | | | | |
| 0 | 01-0 0001 1101 0100 | | | 12:45:12 | prescaler counting normally |
| STOP bi | t is activated by user. | F ₀ F ₁ a | re not rese | t and values ca | nnot be predicted externally |
| 1 | XX-0 0000 0000 0000 | | | 12:45:12 | prescaler is reset; time circuits are frozen |
| New time | e is set by user | | | | |
| 1 | XX-0 0000 0000 0000 | | | 08:00:00 | prescaler is reset; time circuits are frozen |
| STOP bi | t is released by user | | | | |
| 0 | XX-0 0000 0000 0000 | | | 08:00:00 | prescaler is now running |
| | XX-1 0000 0000 0000 | 35 s | | 08:00:00 | - |
| | XX-0 1000 0000 0000 | 5075 | | 08:00:00 | - |
| | XX-1 1000 0000 0000 | to 0. | 111111111111111111111111111111111111111 | 08:00:00 | - |
| | : | 7813 | | : | : |
| | 11-1 1111 1111 1110 | 0.50 | | 08:00:00 | - |
| | 00-0 0000 0000 0001 | | | 08:00:01 | 0 to 1 transition of F ₁₄ increments the time circuits |
| | 10-0 0000 0000 0001 | | | 08:00:01 | - |
| | : | | | : | : |
| | 11-1 1111 1111 1111 | s 000 | | 08:00:01 | - |
| | 00-0 0000 0000 0000 | .00000 | | 08:00:01 | - |
| | 10-0 0000 0000 0000 | _ | | 08:00:01 | - |
| | : | | | : | - |
| | 11-1 1111 1111 1110 | | | 08:00:01 | - |
| | 00-0 0000 0000 0001 | | <u>'</u> | 08:00:02 | 0 to 1 transition of F ₁₄ increments the time circuits |

[1] F_0 is clocked at 32.768 kHz.

The first increment of the time circuits is between 0.507813 s and 0.507935 s after STOP bit is released. The uncertainty is caused by the prescaler bits F_0 and F_1 not being reset (see Table 27) and the unknown state of the 32 kHz clock.

8.11 Reset

The PCF8564A includes an internal reset circuit which is active whenever the oscillator is stopped. In the reset state the I²C-bus logic is initialized including the address pointer and all registers are set according to <u>Table 28</u>. I²C-bus communication is not possible during reset.

Real time clock and calendar

| Table 28. | Register | reset | values |
|-----------|----------|-------|--------|
| | | | |

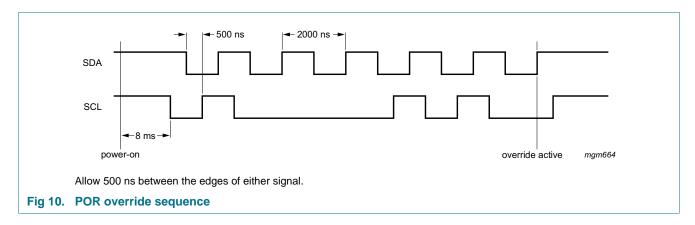
| Address | Register name | Bit | | | | | | | | |
|---------|---------------|-----|---|---|---|---|---|---|---|--|
| | | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| 00h | Control_1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | |
| 01h | Control_2 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| 02h | Seconds | 1 | Х | Х | Х | Χ | Х | Х | х | |
| 03h | Minutes | Х | Х | Х | Х | Χ | Х | Х | х | |
| 04h | Hours | Х | Х | Х | Х | Χ | Х | Х | х | |
| 05h | Days | Х | Х | Х | Х | Χ | Х | Х | х | |
| 06h | Weekdays | Х | Χ | Х | Х | Χ | Х | Х | X | |
| 07h | Months | Х | Χ | Х | Х | Χ | Х | Х | X | |
| 08h | Years | Х | Х | Х | Х | Χ | Х | Х | X | |
| 09h | Minute_alarm | 1 | Χ | Х | Х | Χ | Х | Х | X | |
| 0Ah | Hour_alarm | 1 | Х | Х | Х | Χ | Х | Х | X | |
| 0Bh | Day_alarm | 1 | Χ | Х | Х | Χ | Х | Х | X | |
| 0Ch | Weekday_alarm | 1 | Х | Х | Х | Χ | Х | Х | X | |
| 0Dh | CLKOUT_ctrl | 1 | Х | Х | Х | Х | Х | 0 | 0 | |
| 0Eh | Timer_ctrl | 0 | Х | Х | Х | Х | Х | 1 | 1 | |
| 0Fh | Timer | Х | Х | Х | Х | Х | Х | Х | х | |

^[1] Registers marked 'x' are undefined at power-on and unchanged by subsequent resets.

8.11.1 Power-On Reset (POR) override

The POR duration is directly related to the crystal oscillator start-up time. Due to the long start-up times experienced by these types of circuits, a circuit has been implemented to disable the POR and speed up functional test of the module. The setting of this mode requires that the I²C signals on the pins SDA and SCL are toggled as illustrated in Figure 10. All timings shown are required minimums.

Once the override mode has been entered, the chip immediately stops, being reset, and normal operation may begin, i.e., entry into the EXT_CLK test mode via I²C access. The override mode may be cleared by writing logic 0 to TESTC. TESTC must be set to logic 1 before re-entry into the override mode is possible. Setting TESTC to logic 0 during normal operation has no effect, except to prevent entry into the POR override mode.



PCF8564A

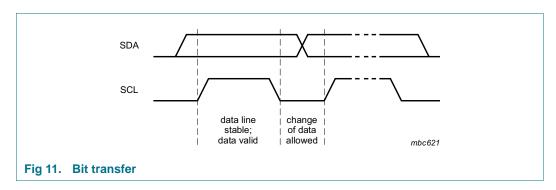
Real time clock and calendar

9. Characteristics of the I²C-bus

The I²C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a Serial DAta line (SDA) and a Serial CLock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

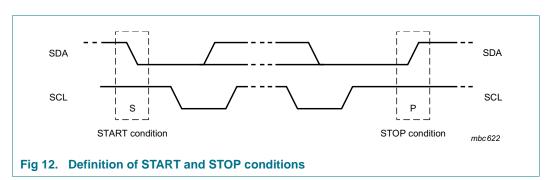
9.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal (see Figure 11).



9.2 START and STOP conditions

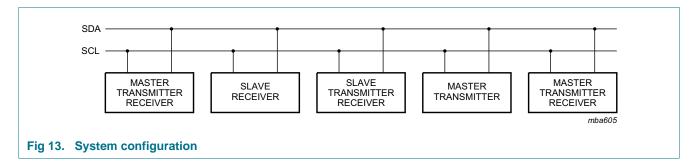
Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH, is defined as the START condition (S). A LOW-to-HIGH transition of the data line, while the clock is HIGH, is defined as the STOP condition (P), see Figure 12.



9.3 System configuration

A device generating a message is a transmitter, a device receiving a message is the receiver. The device that controls the message is the master; and the devices which are controlled by the master are the slaves (see <u>Figure 13</u>).

Real time clock and calendar

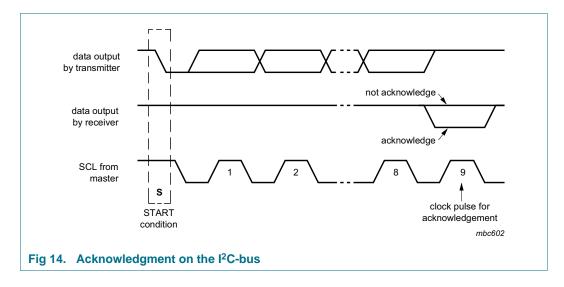


9.4 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of eight bits is followed by an acknowledge cycle.

- A slave receiver, which is addressed, must generate an acknowledge after the reception of each byte.
- Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.
- The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration).
- A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

Acknowledgement on the I²C-bus is shown in Figure 14.



Real time clock and calendar

10. I²C-bus protocol

10.1 Addressing

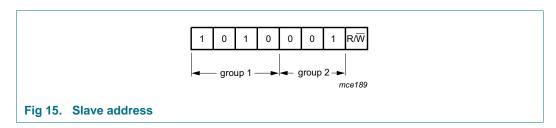
Before any data is transmitted on the I²C-bus, the device which should respond is addressed first. The addressing is always carried out with the first byte transmitted after the start procedure.

The PCF8564A acts as a slave receiver or slave transmitter. Therefore, the clock signal SCL is only an input signal, but the data signal SDA is a bidirectional line.

Two slave addresses are reserved for the PCF8564A:

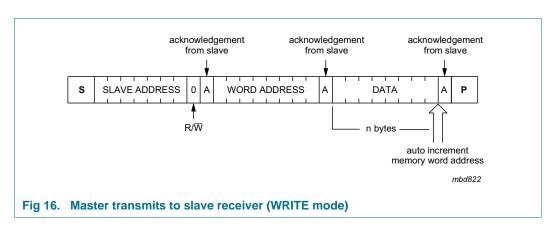
Read: A3h (1010 0011) Write: A2h (1010 0010)

The PCF8564A slave address is shown in Figure 14.

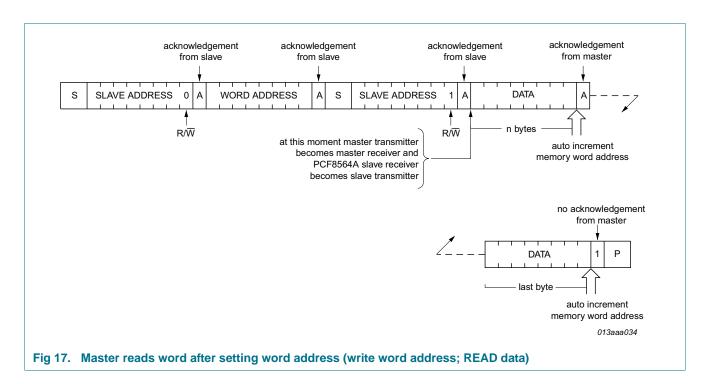


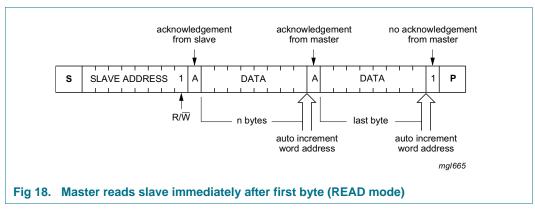
10.2 Clock and calendar READ or WRITE cycles

<u>Figure 16</u>, <u>Figure 17</u>, and <u>Figure 18</u> show the I²C-bus configuration for the different PCF8564A READ and WRITE cycles. The word address is a 4-bit value that defines which register is to be accessed next. The upper four bits of the word address are not used.



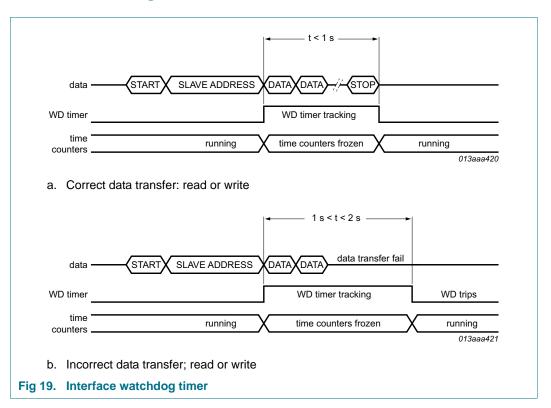
Real time clock and calendar





Real time clock and calendar

10.3 Interface watchdog timer

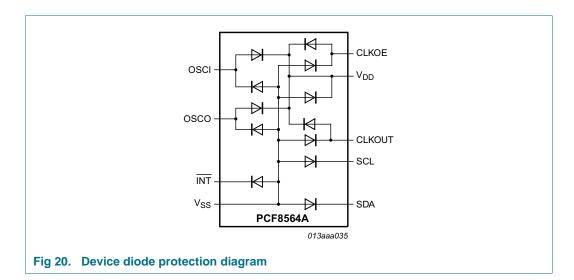


During read/write operations, the time counting circuits are frozen. To prevent a situation where the accessing device becomes locked and does not clear the interface, the PCF8564A has a built in watchdog timer. Should the interface be active for more than 1 s from the time a valid slave address is transmitted, then the PCF8564A will automatically clear the interface and allow the time counting circuits to continue counting. The watchdog will trigger between 1 s and 2 s after receiving a valid slave address. Each time the watchdog period is exceeded, 1 s will be lost from the time counters.

The watchdog is implemented to prevent the excessive loss of time due to interface access failure e.g. if main power is removed from a battery backed-up system during an interface access.

Real time clock and calendar

11. Internal circuitry



12. Safety notes

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

CAUTION



Semiconductors are light sensitive. Exposure to light sources can cause the IC to malfunction. The IC must be protected against light. The protection must be applied to all sides of the IC.

Real time clock and calendar

13. Limiting values

Table 29. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|-------------------|----------------|-------|------|
| V_{DD} | supply voltage | | -0.5 | +6.5 | V |
| V_{I} | input voltage | | -0.5 | +6.5 | V |
| Vo | output voltage | | -0.5 | +6.5 | V |
| I_{DD} | supply current | | -50.0 | +50.0 | mA |
| I _I | input current | | -10.0 | +10.0 | mA |
| Io | output current | | -10.0 | +10.0 | mA |
| I _{SS} | ground supply current | | -50.0 | +50.0 | mA |
| P _{tot} | total power dissipation | | - | 300 | mW |
| V_{ESD} | electrostatic | HBM | [1] - | ±3500 | V |
| | discharge voltage | MM | [2] _ | ±250 | V |
| I _{lu} | latch-up current | all pins but OSCI | [3] - | 100 | mA |
| T _{stg} | storage temperature | | <u>[4]</u> –65 | +150 | °C |
| T _{amb} | ambient temperature | operating device | -40 | +85 | °C |

^[1] Pass level; Human Body Model (HBM) according to Ref. 5 "JESD22-A114".

^[2] Pass level; Machine Model (MM), according to Ref. 6 "JESD22-A115".

^[3] Pass level; latch-up testing, according to Ref. 7 "JESD78" at maximum ambient temperature (T_{amb(max)}).

^[4] According to the NXP store and transport conditions (see Ref. 11 "UM10569") the devices have to be stored at a temperature of +5 °C to +45 °C and a humidity of 25 % to 75 %.

Real time clock and calendar

14. Static characteristics

Table 30. Static characteristics

 V_{DD} = 1.8 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C; f_{osc} = 32.768 kHz; quartz R_s = 40 k Ω ; C_L = 8 pF; unless otherwise specified.

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------|-------------------------------|--|----------------|-------------|------|-----------------------|------|
| Supplies | | | | | | | |
| V_{DD} | supply voltage | interface inactive; $T_{amb} = 25 ^{\circ}C$ | <u>[1]</u> | 1.0 | - | 5.5 | V |
| | supply voltage supply current | interface active; f _{SCL} = 400 kHz | [1] | 1.8 | - | 5.5 | V |
| | | for clock data integrity; T _{amb} = 25 °C | | V_{low} | - | 5.5 | V |
| I _{DD} | supply current | interface active | | | | | |
| | | $f_{SCL} = 400 \text{ kHz}$ | | - | - | 800 | μΑ |
| | | $f_{SCL} = 100 \text{ kHz}$ | | - | - | 200 | μΑ |
| | | interface inactive (f _{SCL} = 0 Hz); CLKOUT disabled; T _{amb} = 25 °C | [2] [3] [4] | | | | |
| | | $V_{DD} = 5.0 \text{ V}$ | | - | 275 | 550 | nΑ |
| | | $V_{DD} = 3.0 \text{ V}$ | | - | 250 | 500 | nA |
| | | $V_{DD} = 2.0 \text{ V}$ | | - | 225 | 450 | nA |
| | | interface inactive ($f_{SCL} = 0 \text{ Hz}$); CLKOUT disabled; $T_{amb} = -40 \text{ °C to } +85 \text{ °C}$ | [2] [3] [4] | | | | |
| | | $V_{DD} = 5.0 \text{ V}$ | | - | 500 | 750 | nA |
| | | $V_{DD} = 3.0 \text{ V}$ | | - | 400 | 650 | nΑ |
| | | $V_{DD} = 2.0 \text{ V}$ | | - | 400 | 600 | nΑ |
| | | interface inactive (f _{SCL} = 0 Hz); CLKOUT enabled at 32 kHz; T _{amb} = 25 °C | [4] [5] [6] | | | | |
| | | $V_{DD} = 5.0 \text{ V}$ | | - | 1500 | 3000 | nΑ |
| | | $V_{DD} = 3.0 \text{ V}$ | | - | 1000 | 2000 | nA |
| | | $V_{DD} = 2.0 \text{ V}$ | | - | 700 | 1400 | nA |
| | | interface inactive ($f_{SCL} = 0 \text{ Hz}$); CLKOUT enabled at 32 kHz; $T_{amb} = -40 \text{ °C to } +85 \text{ °C}$ | [4] [5] [6] | | | | |
| | | $V_{DD} = 5.0 \text{ V}$ | | - | 1700 | 3400 | nΑ |
| | | $V_{DD} = 3.0 \text{ V}$ | | - | 1100 | 2200 | nΑ |
| | | $V_{DD} = 2.0 \text{ V}$ | | - | 800 | 1600 | nΑ |
| Inputs | | | | | | | |
| V _I | input voltage | on pins SDA and SCL | | -0.5 | - | +5.5 | V |
| | | on pins CLKOE and CLKOUT (test mode) | | -0.5 | - | V _{DD} + 0.5 | V |
| V _{IL} | LOW-level input voltage | | | - | - | $0.3V_{DD}$ | V |
| V _{IH} | HIGH-level input voltage | | | $0.7V_{DD}$ | - | - | V |

Real time clock and calendar

Table 30. Static characteristics ... continued

 $V_{DD}=1.8~V$ to 5.5 V; $V_{SS}=0~V$; $T_{amb}=-40~^{\circ}\text{C}$ to +85 $^{\circ}\text{C}$; $f_{osc}=32.768~kHz$; quartz $R_{s}=40~k\Omega$; $C_{L}=8~pF$; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|---------------------------|--|--------------|-----|--|---------------------------------|
| I _{LI} | input leakage current | $V_I = V_{SS}$ or V_{DD} | - | 0 | - | μΑ |
| | | post ESD event | -1 | - | +1 | μΑ |
| Ci | input capacitance | | <u>[7]</u> - | - | 7 | pF |
| Outputs | | | | | | |
| Vo | output voltage | on pin CLKOUT | -0.5 | 0 - | V | |
| | | on pin $\overline{\text{INT}}$ | -0.5 | - | - μA +1 μA 7 pF V _{DD} + 0.5 V +5.5 V - mA - mA - mA - μA | |
| OL | LOW-level output current | on pin SDA; $V_{OL} = 0.4 \text{ V}; V_{DD} = 5 \text{ V}$ | 3 | - | - | mA |
| | | on pin \overline{INT} ; $V_{OL} = 0.4 \text{ V}$; $V_{DD} = 5 \text{ V}$ | -1 | - | - | mA |
| | | on pin CLKOUT: V _{OL} = 0.4 V; V _{DD} = 5 V | -1 | - | - | mA |
| I _{OH} | HIGH-level output current | on pin CLKOUT; $V_{OH} = 4.6 \text{ V}; V_{DD} = 5 \text{ V}$ | 1 | - | - | mA |
| I _{LO} | output leakage current | $V_O = V_{SS}$ or V_{DD} | - | 0 | - | μΑ |
| | | post ESD event | -1 | - | +1 | V mA mA mA μA μA |
| Voltage de | etector | | | | | |
| V _{low} | low voltage | T _{amb} = 25 °C | - | 0.9 | 1.0 | V |

^[1] For reliable oscillator start-up at power-on: $V_{DD(po)min} = V_{DD(min)} + 0.3 \text{ V}$.

^[2] Timer source clock = $\frac{1}{60}$ Hz.

^[3] CLKOUT disabled (FE = 0 or CLKOE = 0).

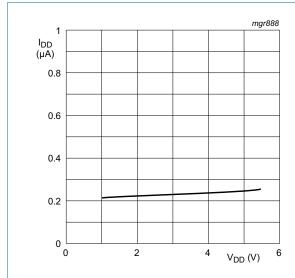
^[4] V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD} .

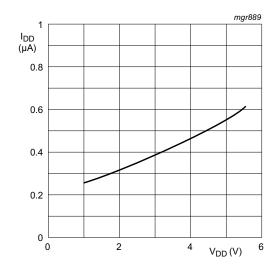
^[5] CLKOUT is open circuit.

^[6] Current consumption when the CLKOUT pin is enabled is a function of the load on the pin, the output frequency, and the supply voltage. The additional current consumption for a given load is calculated from: $I_{DD} = C \times V_{DD} \times F_{CLKOUT}$.

^[7] Tested on sample basis.

Real time clock and calendar





 T_{amb} = 25 °C; timer = 1 minute; CLKOUT disabled.

 T_{amb} = 25 °C; timer = 1 minute; CLKOUT = 32 kHz.

Fig 21. I_{DD} as a function of V_{DD}

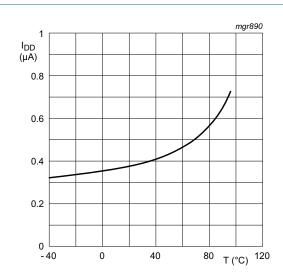
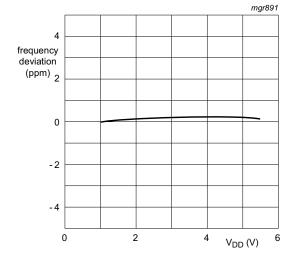


Fig 22. I_{DD} as a function of V_{DD}



 $V_{DD} = 3 \text{ V}$; timer = 1 minute; CLKOUT = 32 kHz.

Fig 23. I_{DD} as a function of temperature

 T_{amb} = 25 °C; normalized to V_{DD} = 3 V.

Fig 24. Frequency deviation as a function of V_{DD}

Real time clock and calendar

15. Dynamic characteristics

Table 31. Dynamic characteristics

 V_{DD} = 1.8 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C; f_{osc} = 32.768 kHz; quartz R_s = 40 k Ω ; C_L = 8 pF; unless otherwise specified.

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|----------------------------------|--|--|-----|-----|-----|-----|-----------|
| Oscillator | | | | | | | |
| C _{L(itg)} | integrated load capacitance | | [1] | 6 | 8 | 10 | pF |
| $\Delta f_{\rm osc}/f_{\rm osc}$ | relative oscillator frequency variation | ΔV_{DD} = 200 mV; T_{amb} = 25 °C | | - | 0.2 | - | ppm |
| Quartz cry | stal parameters | | | | | | |
| R _s | series resistance | | | - | - | 100 | $k\Omega$ |
| C_L | load capacitance | | | - | 8 | - | pF |
| CLKOUT o | utput | | | | | | |
| δ_{CLKOUT} | duty cycle on pin CLKOUT | | [2] | - | 50 | - | % |
| I ² C-bus tim | ning characteristics (see Figure 2 | <u>5)^{[3][4]}</u> | | | | | |
| f _{SCL} | SCL clock frequency | | | - | - | 400 | kHz |
| t _{HD;STA} | hold time (repeated) START condition | | | 0.6 | - | - | μS |
| t _{SU;STA} | set-up time for a repeated START condition | | | 0.6 | - | - | μS |
| t_{LOW} | LOW period of the SCL clock | | | 1.3 | - | - | μS |
| t _{HIGH} | HIGH period of the SCL clock | | | 0.6 | - | - | μS |
| t _r | rise time of both SDA and SCL signals | | | - | - | 0.3 | μS |
| t _f | fall time of both SDA and SCL signals | | | - | - | 0.3 | μS |
| C _b | capacitive load for each bus line | | | - | - | 400 | pF |
| t _{SU;DAT} | data set-up time | | | 100 | - | - | ns |
| t _{HD;DAT} | data hold time | | | 0 | - | - | ns |
| t _{SU;STO} | set-up time for STOP condition | | | 0.6 | - | - | μS |
| t _{w(spike)} | spike pulse width | | | - | - | 50 | ns |

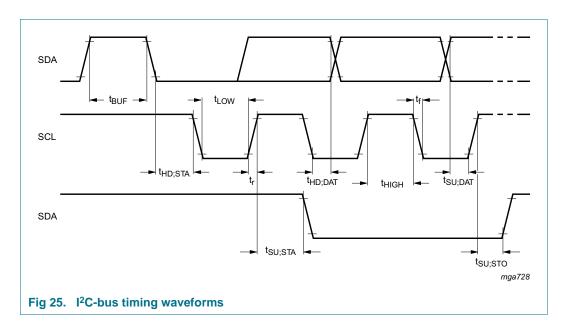
^[1] Integrated load capacitance, $C_{L(itg)}$, is a calculation of C_{OSCI} and C_{OSCO} in series: $C_{L(itg)} = \frac{(C_{OSCI} \cdot C_{OSCO})}{(C_{OSCI} + C_{OSCO})}$.

^[2] Unspecified for f_{CLKOUT} = 32.768 kHz.

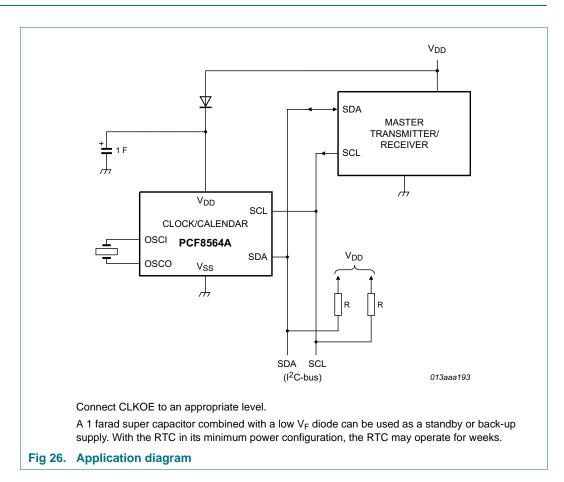
^[3] All timing values are valid within the operating supply voltage at ambient temperature and referenced to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD}.

^[4] A detailed description of the I²C-bus specification is given in Ref. 9 "UM10204".

Real time clock and calendar



16. Application information



Real time clock and calendar

17. Bare die outline

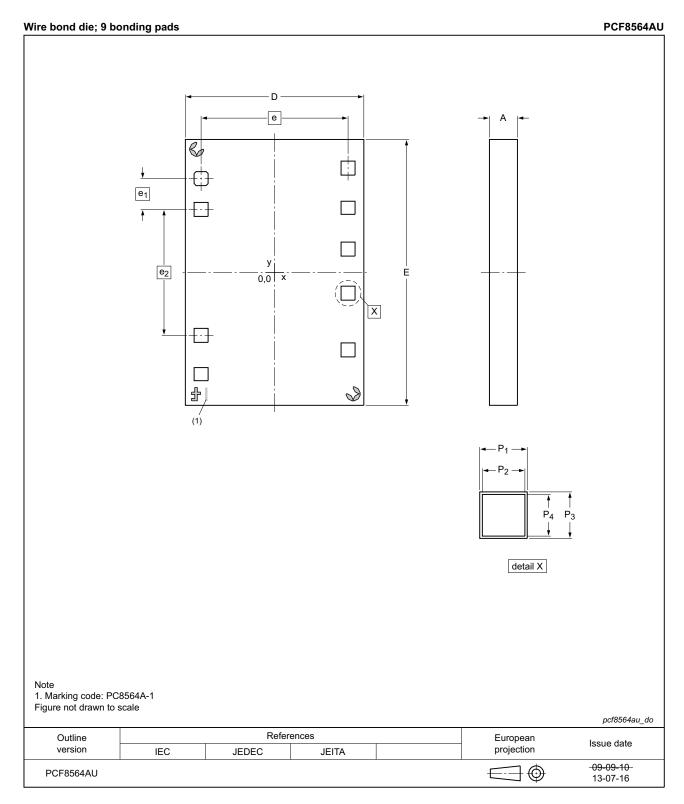


Fig 27. Bare die outline of PCF8564AU/x

F8564A All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2013. All rights reserved.

Real time clock and calendar

Table 32. Dimensions of PCF8564AU/x

Chip dimensions including saw line. Original dimensions are in mm.

| Unit (mm) | Α | D | E | е | e ₁ | e ₂ | P ₁ | P_2 | P_3 | P ₄ |
|-----------|------------|------|------|------|----------------|----------------|----------------|-------|-------|----------------|
| max | - | - | - | - | - | - | - | - | - | - |
| nom | <u>[1]</u> | 1.26 | 1.89 | 1.05 | 0.22 | 0.9 | 0.1 | 0.09 | 0.1 | 0.09 |
| min | - | - | - | - | - | - | - | - | - | - |

^[1] Depending on wafer thickness, see <u>Table 37</u>.

Real time clock and calendar

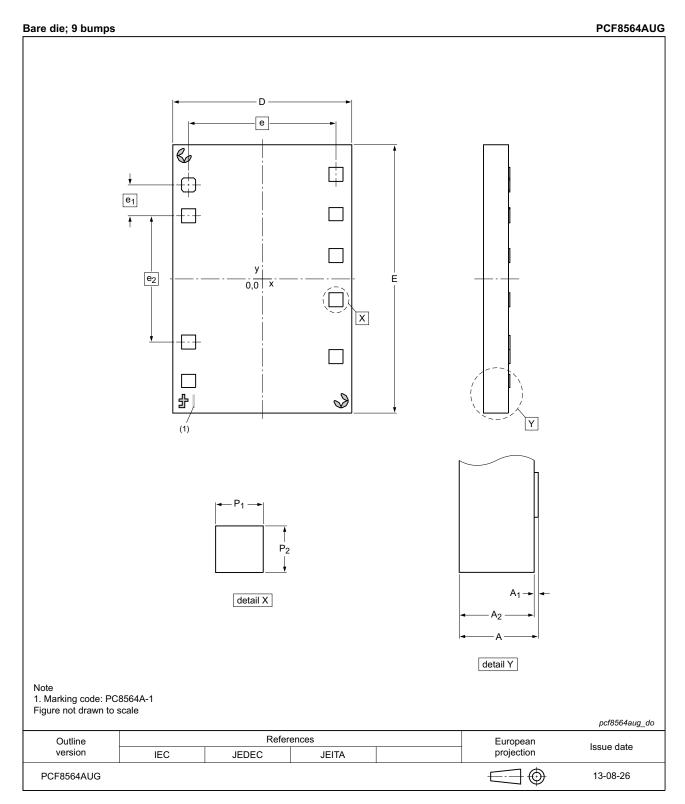


Fig 28. Bare die outline of PCF8564AUG/x

Real time clock and calendar

Table 33. Dimensions of PCF8564AUG/x

Chip dimensions including saw line. Original dimensions are in mm.

| Unit (mm) | Α | A_1 | A_2 | D | Е | е | e ₁ | e ₂ | P ₁ | P ₂ |
|-----------|------------|-------|------------|------|------|------|----------------|----------------|----------------|----------------|
| max | - | - | - | - | - | - | - | - | - | - |
| nom | <u>[1]</u> | 0.015 | <u>[1]</u> | 1.26 | 1.89 | 1.05 | 0.22 | 0.9 | 0.09 | 0.09 |
| min | - | - | - | - | - | - | - | - | - | - |

^[1] Depending on wafer thickness, see Table 37.

Real time clock and calendar

Table 34. Pin location of all PCF8564A types

All x/y coordinates represent the position of the center of each pin with respect to the center (x/y = 0) of the chip; see <u>Figure 27</u> and <u>Figure 28</u>.

| Symbol | Pad | X (μm) | Υ (μm) | Description |
|-----------------|-----|--------|--------|--|
| OSCI | 1 | -523.0 | 689.4 | oscillator input |
| OSCO | 2 | -523.0 | 469.4 | oscillator output |
| INT | 3 | -523.0 | -429.8 | open-drain interrupt output (active LOW) |
| V _{SS} | 4 | -523.0 | -684.4 | ground (substrate) |
| SDA | 5 | 524.9 | -523.8 | serial data I/O |
| SCL | 6 | 524.9 | -138.6 | serial clock input |
| CLKOUT | 7 | 524.9 | 162.5 | CMOS push-pull clock output |
| V_{DD} | 8 | 524.9 | 443.3 | supply |
| CLKOE | 9 | 524.9 | 716.3 | CLKOUT output enable |

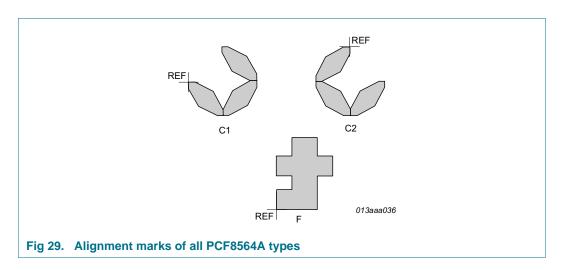


Table 35. Alignment marks of all PCF8564A types

All x/y coordinates represent the position of the REF point (see <u>Figure 29</u>) with respect to the center (x/y = 0) of the chip; see <u>Figure 27</u> and <u>Figure 28</u>.

| Alignment markers | Size (μm) | X (μm) | Υ (μm) |
|-------------------|-----------|--------|--------|
| C1 | 100 × 100 | 465.2 | -826.3 |
| C2 | 100 × 100 | -523.0 | 890.0 |
| F | 90 × 117 | -569.9 | -885.5 |

Table 36. Gold bump hardness

| Type number | Min | Max | Unit ^[1] | |
|-------------------|-----|-----|---------------------|--|
| PCF8564AUG/12HB/1 | 35 | 80 | HV | |

[1] Pressure of diamond head: 10 g to 50 g.

Real time clock and calendar

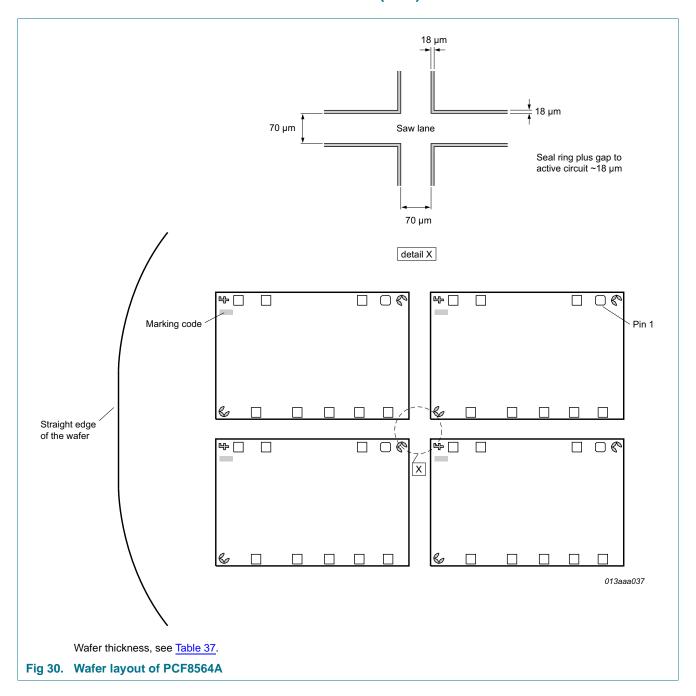
18. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

Real time clock and calendar

19. Packing information

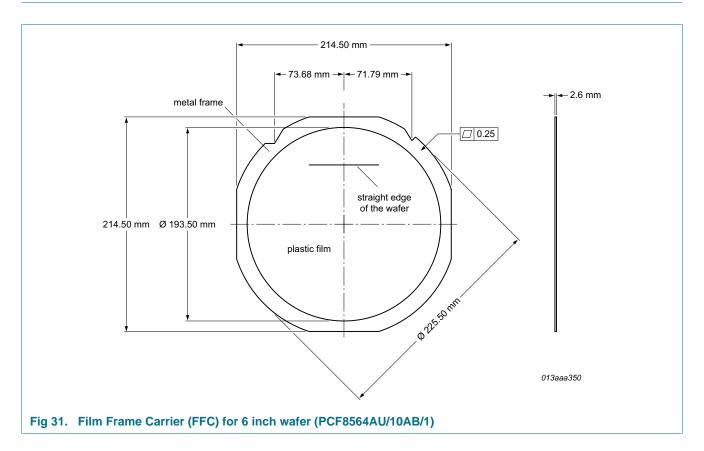
19.1 Wafer and Film Frame Carrier (FFC) information



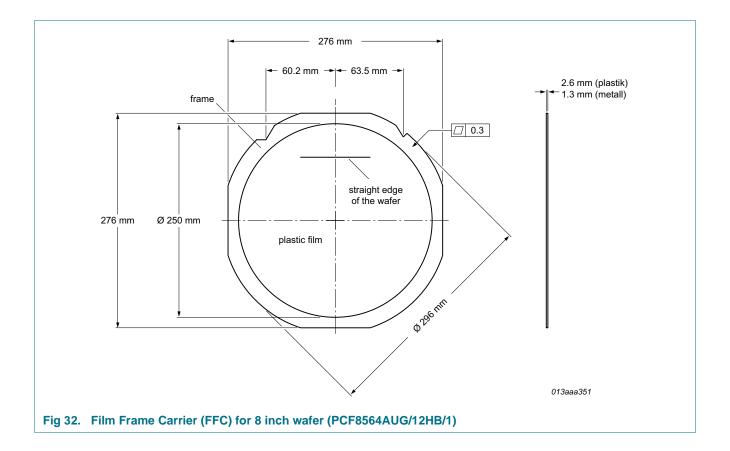
Real time clock and calendar

Table 37. PCF8564A wafer information

| Type number | Wafer thickness | Wafer diameter | FFC for wafer size | Marking of bad die |
|-------------------|-----------------|----------------|--------------------|--------------------|
| PCF8564AU/5BB/1 | 0.28 mm | 6 inch | - | inking |
| PCF8564AU/5GB/1 | 0.69 mm | 6 inch | - | inking |
| PCF8564AU/5GC/1 | 0.69 mm | 6 inch | - | wafer mapping |
| PCF8564AU/10AB/1 | 0.20 mm | 6 inch | 6 inch | inking |
| PCF8564AUG/12HB/1 | 0.15 mm | 6 inch | 8 inch | inking |



Real time clock and calendar



Real time clock and calendar

20. Abbreviations

Table 38. Abbreviations

| 14510 001 715510 | |
|------------------|---|
| Acronym | Description |
| BCD | Binary Coded Decimal |
| CMOS | Complementary Metal Oxide Semiconductor |
| FFC | Film Frame Carrier |
| НВМ | Human Body Model |
| I ² C | Inter-Integrated Circuit |
| IC | Integrated Circuit |
| LSB | Least Significant Bit |
| MM | Machine Model |
| MOS | Metal Oxide Semiconductor |
| MSB | Most Significant Bit |
| MSL | Moisture Sensitivity Level |
| PCB | Printed-Circuit Board |
| POR | Power-On Reset |
| ROM | Read Only Memory |
| RTC | Real Time Clock |
| SCL | Serial CLock line |
| SDA | Serial DAta line |
| | |

21. References

- [1] AN10439 Wafer Level Chip Size Package
- [2] AN10706 Handling bare die
- [3] IEC 60134 Rating systems for electronic tubes and valves and analogous semiconductor devices
- [4] IEC 61340-5 Protection of electronic devices from electrostatic phenomena
- [5] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [6] **JESD22-A115** Electrostatic Discharge (ESD) Sensitivity Testing Machine Model (MM)
- [7] JESD78 IC Latch-Up Test
- [8] **JESD625-A** Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [9] UM10204 I²C-bus specification and user manual
- [10] UM10301 User Manual for NXP Real Time Clocks PCF85x3, PCA8565 and PCF2123, PCA2125
- [11] UM10569 Store and transport requirements

Real time clock and calendar

22. Revision history

Table 39. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-------------------|----------------------------------|--------------------------------|---------------|--------------|
| PCF8564A v.3 | 20130826 | Product data sheet | - | PCF8564A v.2 |
| Modifications: | adjusted pro | oduct and ordering information | | |
| ● added Figure 19 | | | | |
| PCF8564A v.2 | 20100930 | Product data sheet | - | PCF8564A v.1 |
| PCF8564A v.1 | 20091008 | Product data sheet | - | - |

Real time clock and calendar

23. Legal information

23.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition | |
|--|-------------------|---|--|
| Objective [short] data sheet Development Preliminary [short] data sheet Qualification | | This document contains data from the objective specification for product development. | |
| | | This document contains data from the preliminary specification. | |
| Product [short] data sheet | Production | This document contains the product specification. | |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

23.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

23.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

PCF8564A

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2013. All rights reserved.

Real time clock and calendar

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

Bare die — All die are tested on compliance with their related technical specifications as stated in this data sheet up to the point of wafer sawing and are handled in accordance with the NXP Semiconductors storage and transportation conditions. If there are data sheet limits not guaranteed, these will be separately indicated in the data sheet. There are no post-packing tests performed on individual die or wafers.

NXP Semiconductors has no control of third party procedures in the sawing, handling, packing or assembly of the die. Accordingly, NXP Semiconductors assumes no liability for device functionality or performance of the die or systems after third party sawing, handling, packing or assembly of the die. It is the responsibility of the customer to test and qualify their application in which the die is used.

All die sales are conditioned upon and subject to the customer entering into a written die sale agreement with NXP Semiconductors through its legal department.

23.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

I²C-bus — logo is a trademark of NXP B.V.

24. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

Real time clock and calendar

25. Tables

| Table 1. | Ordering information | 2 |
|-----------|--|------|
| Table 2. | Ordering options | |
| Table 3. | Marking codes | |
| Table 4. | Pin description | |
| Table 5. | Register overview | |
| Table 5. | Control_1 - control and status register 1 | 0 |
| Table 6. | (address 00h) bit description | 7 |
| Table 7. | Control_2 - control and status register 2 | / |
| Table 7. | (address 01h) bit description | 7 |
| Table 8. | INT operation (bit TI_TP = 1)[1] | |
| Table 9. | Seconds - seconds and clock integrity status | 0 |
| Table 3. | register (address 02h) bit description | ۵ |
| Table 10. | Seconds coded in BCD format | |
| Table 10. | Minutes - minutes register (address 03h) | 9 |
| Table 11. | bit description | 10 |
| Table 12. | Hours - hours register (address 04h) | . 10 |
| Table 12. | bit description | 10 |
| Toble 12 | Dave dave register (address 05h) | . 10 |
| Table 13. | | 10 |
| Toble 14 | bit description | . 10 |
| Table 14. | | 10 |
| Toble 15 | (address 06h) bit description | |
| Table 16. | Weekday assignments | . 11 |
| Table 16. | mental mental control of the great control of the g | 44 |
| Table 47 | (address 07h) bit description | |
| Table 17. | Month assignments coded in BCD format | |
| Table 18. | Years - years register (08h) bit description | .12 |
| Table 19. | Minute_alarm - minute alarm register | 40 |
| T-1-1- 00 | (address 09h) bit description | .13 |
| Table 20. | Hour_alarm - hour alarm register | |
| Table 04 | (address 0Ah) bit description | .14 |
| Table 21. | Day_alarm - day alarm register | 4.4 |
| Table 00 | (address 0Bh) bit description | .14 |
| Table 22. | | 4.4 |
| Table 00 | (address 0Ch) bit description | .14 |
| Table 23. | - | 40 |
| T-1-1- 04 | (address 0Dh) bit description | .16 |
| Table 24. | ····· | 40 |
| Table OF | (address 0Eh) bit description | .16 |
| Table 25. | | 47 |
| Table 00 | bit description | |
| Table 26. | Timer register bits value range | .17 |
| rable 27. | First increment of time circuits after STOP | 40 |
| T-1-1- 00 | bit release | |
| Table 28. | Register reset values 1 | |
| Table 29. | Limiting values | |
| Table 30. | Static characteristics | |
| Table 31. | Dynamic characteristics | |
| Table 32. | Dimensions of PCF8564AU/x | |
| Table 33. | Dimensions of PCF8564AUG/x | |
| Table 34. | Pin location of all PCF8564A types | |
| Table 35. | Alignment marks of all PCF8564A types | |
| Table 36. | Gold bump hardness | |
| Table 37. | PCF8564A wafer information | |
| Table 38. | Abbreviations | |
| Table 39. | Revision history | .43 |

Real time clock and calendar

26. Figures

| Fig 1. | Block diagram of PCF8564A | 3 |
|---------|--|-----|
| Fig 2. | Pinning diagram of PCF8564A | 4 |
| Fig 3. | Interrupt scheme | 8 |
| Fig 4. | Voltage low detection | |
| Fig 5. | Data flow for the time function | .12 |
| Fig 6. | Access time for read/write operations | .13 |
| Fig 7. | Alarm function block diagram | .15 |
| Fig 8. | STOP bit functional diagram | .18 |
| Fig 9. | STOP bit release timing | |
| Fig 10. | POR override sequence | .20 |
| Fig 11. | Bit transfer | .21 |
| Fig 12. | Definition of START and STOP conditions | .21 |
| Fig 13. | System configuration | .22 |
| Fig 14. | Acknowledgment on the I ² C-bus | .22 |
| Fig 15. | Slave address | .23 |
| Fig 16. | Master transmits to slave receiver | |
| | (WRITE mode) | .23 |
| Fig 17. | Master reads word after setting word address | |
| | (write word address; READ data) | .24 |
| Fig 18. | Master reads slave immediately after first byte | |
| | (READ mode) | .24 |
| Fig 19. | Interface watchdog timer | .25 |
| Fig 20. | Device diode protection diagram | .26 |
| Fig 21. | I _{DD} as a function of V _{DD} | .30 |
| Fig 22. | I _{DD} as a function of V _{DD} | .30 |
| Fig 23. | I _{DD} as a function of temperature | .30 |
| Fig 24. | Frequency deviation as a function of V _{DD} | .30 |
| Fig 25. | I ² C-bus timing waveforms | |
| Fig 26. | Application diagram | .32 |
| Fig 27. | Bare die outline of PCF8564AU/x | .33 |
| Fig 28. | Bare die outline of PCF8564AUG/x | |
| Fig 29. | Alignment marks of all PCF8564A types | .37 |
| Fig 30. | Wafer layout of PCF8564A | .39 |
| Fig 31. | Film Frame Carrier (FFC) for 6 inch wafer | |
| | (PCF8564AU/10AB/1) | .40 |
| Fig 32. | Film Frame Carrier (FFC) for 8 inch wafer | |
| | (PCF8564AUG/12HB/1) | .41 |

Real time clock and calendar

27. Contents

| 2 Features and benefits 1 10 IPC-bus protocol 23 3 Applications 1 10.1 Addressing 23 4 Ordering information 2 10.3 Clock and calendar READ or WRITE cycles 23 4.1 Ordering options 2 10.3 Internal circuitry 25 5 Marking 2 11 Internal circuitry 26 6 Block diagram 3 12 Safety notes 26 7 Pinning information 4 13 Limiting values 27 7.1 Pinning 4 14 Static characteristics 28 8 Functional description 5 16 Application information 32 8.1 CLKOUT output 5 17 Bare die outline 33 8.2 Register Organization 6 18 Handling information 38 8.3 Control registers 7 19 1 Packing information 39 <th>1</th> <th>General description</th> <th>9.4</th> <th>Acknowledge</th> <th>22</th> | 1 | General description | 9.4 | Acknowledge | 22 |
|--|---------|---------------------|------|---------------------|----|
| 3 Applications 1 10.1 Addressing 23 4 Ordering information 2 10.2 Clock and calendar READ or WRITE cycles 23 4.1 Ordering options 2 10.3 Interface watchdog timer 25 5 Marking 2 11 Internal circuitry 26 6 Block diagram 3 12 Safety notes 26 7 Pinning information 4 13 Limiting values 27 7.1 Pinning 4 14 Static characteristics 28 8 Functional description 5 16 Application information 32 8.1 CLKOUT output 5 16 Application information 32 8.2 Register Control 1 7 17 Bare die outline 33 8.3.1 Register Control 1 7 19 Packing information 38 8.3.2 Register Control 1 7 19.1 Packing information 39 8.4.1 Time and date registers 9 20 Abbreviations 42 8.4.1 Register Must 9 21 Ref | | | 10 | - | |
| 44 Ordering information. 2 10.2 Clock and calendar READ or WRITE cycles. 23 4.1 Ordering options. 2 10.3 Interface watchdog timer. 25 5 Marking. 2 11 Internal circuitry. 26 6 Block diagram. 3 12 Safety notes. 26 7 Pinning information. 4 13 Limiting values. 27 7.1 Pinning. 4 14 Static characteristics. 28 7.2 Pin description. 5 16 Application information. 32 8.8 Functional description. 5 16 Application information. 32 8.1 CLKOUT output. 5 16 Application information. 32 8.2 Register Organization. 6 18 Handling information. 38 8.3 Control registers. 7 19 Packing information. 39 8.3 Register Control. 7 19.1 Wafer and Film | | | - | | |
| At Ordering options 2 | | | - | | |
| 5 Marking 2 11 Internal circuitry 26 6 Block diagram 3 12 Safety notes 26 7 Pinning information 4 13 Limiting values 27 7.1 Pinning 4 14 Static characteristics 28 7.2 Pin description 4 15 Dynamic characteristics 33 8.1 CLKOUT output 5 16 Application information 32 8.2 Register Organization 6 18 Handling information 38 8.2 Register Control -1 7 19 Packing information 38 8.3 Control registers 7 19 Packing information 38 8.3.1 Register Control -2 7 19.1 Wafer and Film Frame Carrier (FFC) information 39 8.4.1 Register Control -2 7 19.1 Wafer and Film Frame Carrier (FFC) information 39 8.4.1 Register Minutes 10 23 Legal i | | _ | 10.3 | | |
| 6 Block diagram 3 12 Safety notes 26 7 Pinning information 4 13 Limiting values 27 7.1 Pinning 4 14 Static characteristics 28 8 Functional description 5 16 Application information 32 8.1 CLKOUT output 5 17 Bare die outline 33 8.2 Register organization 6 18 Handling information 38 8.3 Control registers 7 19 Packing information 38 8.3.1 Register Control 1 7 19.1 Packing information 39 8.3.1 Interrupt output 8 20 Abbreviations 39 8.4.1 Register Seconds 9 21 References 42 8.4.1 Register Davis 9 21 References 42 8.4.1.1 Voltage low detector and clock monitor 9 22 Revision history 43 <tr< td=""><td></td><td>• .</td><td>11</td><td>Internal circuitry</td><td>26</td></tr<> | | • . | 11 | Internal circuitry | 26 |
| 7 Pinning Information 4 13 Limiting values 27 7.1 Pinning 4 14 Static characteristics 28 7.2 Pin description 4 15 Dynamic characteristics 31 8 Functional description 5 16 Application information 32 8.1 CLKOUT output 5 17 Bare die outline 33 8.2 Register Control 7 19 Packing information 38 8.3 Control registers 7 19 Packing information 38 8.3.1 Register Control 7 19.1 Wafer and Film Frame Carrier (FFC) information 39 8.3.2.1 Interrupt output 8 4 Abbreviations 42 8.4.1 Register Seconds 9 21 References 42 8.4.1 Register Meelstor and clock monitor 9 22 Revision history 43 8.4.2 Register Hours 10 23.1 Data sheet status <td>_</td> <td></td> <td>12</td> <td>Safety notes</td> <td>26</td> | _ | | 12 | Safety notes | 26 |
| 7.1 Pinning 7.1 Pinning 7.2 Pin description 7.2 Pin description 7.3 Punctional description 7.4 15 Dynamic characteristics 7.5 28 Functional description 7.6 Application information 7.7 Bare die outline 7.7 Bare die outline 7.8 Bare die outli | _ | _ | 13 | Limiting values | 27 |
| Total | | _ | 14 | - | |
| 8 Functional description 5 16 Application information 32 8.1 CLKOUT output 5 17 Bare die outline 33 8.2 Register Orapinization 6 18 Handling information 38 8.3 Control registers 7 19 Packing information 39 8.3.1 Register Control _ 1 7 19.1 Wafer and Film Frame Carrier (FFC) information 39 8.3.2 Register Control _ 2 7 19.1 Wafer and Film Frame Carrier (FFC) information 39 8.3.1 Interrupt output 8 8 20 Abbreviations 42 8.4.1 Register Output output 8 4 20 Abbreviations 42 8.4.1 Register Minutes 9 21 References 42 8.4.1 Register Minutes 10 23 Legal information 44 8.4.2 Register Mours 10 23.1 Data Sheet status 44 8.4.5 Register Weekdays </td <td></td> <td></td> <td>15</td> <td></td> <td></td> | | | 15 | | |
| 8.1 CLKOUT output 5 17 Bare die outline 33 8.2 Register organization 6 18 Handlling information 38 8.3 Control registers 7 19 Packing information 39 8.3.1 Register Control_2 7 7 19.1 Wafer and Film Frame Carrier (FFC) information 39 8.3.2.1 Interrupt output 8 4 Time and date registers 9 20 Abbreviations 42 8.4.1 Register Seconds 9 21 References 42 8.4.1 Register Seconds 9 21 References 42 8.4.1 Register Hours 10 23.1 References 42 8.4.1 Register Hours 10 23.1 Data sheet status 44 8.4.2 Register Hours 10 23.1 Data sheet status 44 8.4.4 Register Weekdays 10 23.2 Definitions 44 8.4.5 Register Weekdays 10 23.3 Disclaimers 42 8.5 <td< td=""><td></td><td></td><td>-</td><td></td><td></td></td<> | | | - | | |
| 8.2 Register organization 6 18 Handling information 38 8.3 Control registers 7 19 Packing information 39 8.3.1 Register Control_2 7 19.1 Wafer and Film Frame Carrier (FFC) information 39 8.4.2 Register Seconds 9 21 References 42 8.4.1 Register Seconds 9 21 References 42 8.4.1 Register Minutes 10 23 Legal information 39 8.4.2 Register Minutes 10 23 Legal information 39 8.4.2 Register Minutes 10 23 Legal information 43 8.4.2 Register Hours 10 23 Legal information 44 8.4.3 Register Plours 10 23 Legal information 44 8.4.4 Register Plours 10 23 Legal information 44 8.4.5 Register Plours 10 23 Definitions 44 8.4.7 Register Months 11 23 Trademark | | | - | | |
| 8.3 Control registers 7 19 Packing information 39 8.3.1 Register Control_1 7 19.1 Wafer and Film Frame Carrier (FC) information 39 8.3.2.1 Interrupt output 8 4 Time and date registers 9 20 Abbreviations 42 8.4.1 Time and date registers 9 21 References 42 8.4.1 Voltage low detector and clock monitor 9 22 Revision history 43 8.4.2 Register Minutes 10 23 Legal information 44 8.4.2 Register Minutes 10 23 Legal information 44 8.4.3 Register Pours 10 23.1 Data sheet status 44 8.4.4 Register Weekdays 10 23.2 Definitions 44 8.4.5 Register Weekdays 10 23.2 Definitions 44 8.4.7 Register Pears 12 24 Contact information 45 8.6 A | - | | | | |
| 8.3.1 Register Control_1 7 19.1 Wafer and Film Frame Carrier (FFC) information 39 8.3.2.1 Interrupt output 8 20 Abbreviations 42 8.4.1 Register Seconds 9 21 References 42 8.4.1.1 Voltage low detector and clock monitor 9 22 Revision history 43 8.4.2 Register Minutes 10 23.1 Legal information 44 8.4.3 Register Days 10 23.1 Data sheet status 44 8.4.4 Register Weekdays 10 23.2 Definitions 44 8.4.4 Register Weekdays 10 23.3 Disclaimers 44 8.4.5 Register Weekdays 10 23.3 Disclaimers 44 8.4.6 Register Years 12 24 Contact information 45 8.5 Setting and reading the time 12 24 Contact information 45 8.6.1 Register Invalation 13 26 Figures 47 8.6.2 Register Imer_ctri 16 | | | _ | _ | |
| 8.3.2 Register Control_2 7 19.1 Water and Frame Callier (FFC) information 39 8.3.2.1 Interrupt output 8 4 Time and date registers 9 20 Abbreviations 42 8.4.1 Register Seconds 9 21 References 42 8.4.1.1 Voltage low detector and clock monitor 9 22 Revision history 43 8.4.2 Register Minutes 10 23.1 Data sheet status 44 8.4.3 Register Hours 10 23.1 Data sheet status 44 8.4.4 Register Days 10 23.2 Definitions 44 8.4.5 Register Weekdays 10 23.3 Disclaimers 44 8.4.6 Register Months 11 23.4 Trademarks 45 8.5 Setting and reading the time 12 24 Contact information 45 8.6 Alarm registers 13 25 Tables 46 8.6.1 Register Minute_alarm 13 26 Figures 47 8.6.2 Register Hour_alarm 14 48 48 8.6.3 Register Timer 17 48 48 48 8.8 Time function 16 | | | | | 39 |
| 8.3.2.1 Interrupt output 8 8.4 Time and date registers 9 8.4.1 Register Seconds 9 8.4.1.1 Voltage low detector and clock monitor 9 22 Revision history 43 8.4.2 Register Minutes 10 8.4.3 Register Hours 10 8.4.4 Register Pays 10 8.4.5 Register Weekdays 10 8.4.6 Register Weekdays 10 8.4.7 Register Weekday 12 8.5 Setting and reading the time 12 8.6 Alarm registers 13 8.6.1 Register Minute_alarm 13 8.6.2 Register Hour_alarm 14 8.6.3 Register Day_alarm 14 8.6.4 Register Weekday_alarm 14 8.6.5 Alarm flag 14 8.7 Register CLKOUT_ctrl and clock output 15 8.8 Time function 16 8.8.1 Register Timer_ctrl 16 8.8.2 Register Timer_ctrl 16 </td <td></td> <td></td> <td>19.1</td> <td></td> <td></td> | | | 19.1 | | |
| 8.4 Time and date registers 9 20 Abbreviations 42 8.4.1 Register Seconds 9 21 References 42 8.4.1.1 Voltage low detector and clock monitor 9 22 Revision history 43 8.4.2 Register Minutes 10 23 Legal information 44 8.4.3 Register Hours 10 23.1 Data sheet status 44 8.4.4 Register Weekdays 10 23.2 Definitions 44 8.4.5 Register Wonths 11 23.4 Trademarks 45 8.4.6 Register Wonths 11 23.4 Trademarks 45 8.4.7 Register Years 12 24 Contact information 45 8.6 Alarm registers 13 26 Figures 47 8.6 Alarm register Pour_alarm 14 27 Contents 48 8.6.1 Register Hour_alarm 14 27 Contents 48 8.6.3 Register Out_alarm 14 27 Contents 48 </td <td></td> <td></td> <td></td> <td></td> <td></td> | | | | | |
| 8.4.1 Register Seconds 9 21 References 42 8.4.1.1 Voltage low detector and clock monitor 9 22 Revision history 43 8.4.2 Register Minutes 10 23 Legal information 44 8.4.3 Register Hours 10 23.1 Data sheet status 44 8.4.4 Register Days 10 23.2 Definitions 44 8.4.5 Register Weekdays 10 23.3 Disclaimers 44 8.4.6 Register Months 11 23.4 Trademarks 45 8.4.7 Register Years 12 24 Contact information 45 8.5 Setting and reading the time 12 25 Tables 46 8.6.1 Register Minute_alarm 13 26 Figures 47 8.6.2 Register Hour_alarm 14 27 Contents 48 8.6.3 Register Day_alarm 14 27 Contents 48 8.6.4 Register Day_alarm 14 27 Contents 48 < | 8.4 | | 20 | Abbreviations | 42 |
| 8.4.1.1 Voltage low detector and clock monitor 9 22 Revision history 43 8.4.2 Register Minutes 10 23 Legal information 44 8.4.3 Register Hours 10 23.1 Data sheet status 44 8.4.4 Register Days 10 23.2 Definitions 44 8.4.5 Register Weekdays 10 23.3 Disclaimers 44 8.4.7 Register Months 11 23.4 Trademarks 45 8.4.7 Register Years 12 24 Contact information 45 8.5 Setting and reading the time 12 24 Contact information 45 8.6 Alarm registers 13 26 Figures 46 8.6.1 Register Hour_alarm 14 27 Contents 48 8.6.2 Register Day_alarm 14 27 Contents 48 8.7 Register Day_alarm 14 27 Contents 48 8.8.1 Register UkCOUT_ctrl and clock output 15 8.8 16 | 8.4.1 | | 21 | References | 42 |
| 8.4.3 Register Hours 10 23.1 Data sheet status 44 8.4.4 Register Days 10 23.2 Definitions 44 8.4.5 Register Weekdays 10 23.3 Disclaimers 44 8.4.6 Register Months 11 23.4 Trademarks 45 8.4.7 Register Years 12 24 Contact information 45 8.5 Setting and reading the time 12 25 Tables 46 8.6 Alarm registers 13 26 Figures 46 8.6.1 Register Minute_alarm 13 26 Figures 47 8.6.2 Register Hour_alarm 14 27 Contents 48 8.6.3 Register Day_alarm 14 27 Contents 48 8.6.4 Register Weekday_alarm 14 27 Contents 48 8.7 Register CLKOUT_ctrl and clock output 15 8.8 Timer function 16 8.8.1 Register Timer_ctrl 16 8.8.2 Register Timer_ctrl 16 8.9.1 Operation example 17 8.11 Reset 19 8.11.1 Power-On Reset (POR) overri | 8.4.1.1 | | 22 | Revision history | 43 |
| 8.4.3 Register Hours 10 23.1 Data sheet status 44 8.4.4 Register Days 10 23.2 Definitions 44 8.4.5 Register Weekdays 10 23.3 Disclaimers 44 8.4.6 Register Months 11 23.4 Trademarks 45 8.4.7 Register Years 12 24 Contact information 45 8.6 Alarm registers 13 25 Tables 46 8.6 Alarm register Minute_alarm 13 26 Figures 47 8.6.1 Register Hour_alarm 14 27 Contents 48 8.6.2 Register Day_alarm 14 48 <td>8.4.2</td> <td>Register Minutes</td> <td>23</td> <td>Legal information</td> <td>44</td> | 8.4.2 | Register Minutes | 23 | Legal information | 44 |
| 8.4.4 Register Days 10 23.2 Definitions 44 8.4.5 Register Weekdays 10 23.3 Disclaimers 44 8.4.6 Register Months 11 23.4 Trademarks 45 8.4.7 Register Years 12 24 Contact information 45 8.5 Setting and reading the time 12 25 Tables 46 8.6 Alarm registers 13 26 Figures 47 8.6.1 Register Minute_alarm 14 27 Contents 48 8.6.2 Register Day_alarm 14 48 48 8.6.3 Register Dewekday_alarm 14 48 48 8.6.4 Register CLKOUT_ctrl and clock output 15 48 8.8 Timer function 16 48 8.8.1 Register Timer 17 49 8.9 EXT_CLK test mode 17 8.9.1 Operation example 17 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 | 8.4.3 | Register Hours | 23.1 | _ | |
| 8.4.6 Register Months 11 23.4 Trademarks 45 8.4.7 Register Years 12 24 Contact information 45 8.5 Setting and reading the time 12 24 Contact information 45 8.6 Alarm registers 13 25 Tables 46 8.6.1 Register Minute_alarm 13 26 Figures 47 8.6.2 Register Hour_alarm 14 27 Contents 48 8.6.3 Register Day_alarm 14 48 <td< td=""><td>_</td><td></td><td></td><td></td><td></td></td<> | _ | | | | |
| 8.4.7 Register Years 12 24 Contact information 45 8.5 Setting and reading the time 12 25 Tables 46 8.6 Alarm registers 13 26 Figures 47 8.6.1 Register Minute_alarm 14 27 Contents 48 8.6.2 Register Day_alarm 14 48 48 8.6.3 Register Weekday_alarm 14 48 48 8.6.5 Alarm flag 14 48 48 48 48 8.7 Register CLKOUT_ctrl and clock output 15 48 | 8.4.5 | | 23.3 | Disclaimers | 44 |
| 8.5 Setting and reading the time. 12 24 Contact mornation. 45 8.6 Alarm registers. 13 25 Tables. 46 8.6.1 Register Minute_alarm. 13 26 Figures. 47 8.6.2 Register Hour_alarm. 14 27 Contents. 48 8.6.3 Register Day_alarm. 14 48 8.6.4 Register Weekday_alarm. 14 48 8.6.5 Alarm flag. 14 48 8.7 Register CLKOUT_ctrl and clock output. 15 48 8.8 Timer function. 16 48 8.8.1 Register Timer_ctrl. 16 48 8.8.2 Register Timer_ctrl. 16 48 8.9.1 Operation example. 17 8.9.1 Operation example. 17 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions | | | 23.4 | Trademarks | 45 |
| 8.5 Setting and reading the time. 12 8.6 Alarm registers . 13 8.6.1 Register Minute_alarm . 13 8.6.2 Register Hour_alarm . 14 8.6.3 Register Day_alarm . 14 8.6.4 Register Weekday_alarm . 14 8.6.5 Alarm flag . 14 8.7 Register CLKOUT_ctrl and clock output . 15 8.8 Timer function . 16 8.8.1 Register Timer_ctrl . 16 8.8.2 Register Timer . 17 8.9 EXT_CLK test mode . 17 8.9 EXT_CLK test mode . 17 8.9.1 Operation example . 17 8.10 STOP bit function . 18 8.11 Reset . 19 8.11.1 Power-On Reset (POR) override . 20 9 Characteristics of the I²C-bus . 21 9.1 Bit transfer . 21 9.2 START and STOP conditions . 21 | | | 24 | Contact information | 45 |
| 8.6.1 Register Minute_alarm | | | 25 | | |
| 8.6.2 Register Hour_alarm 14 27 Contents 48 8.6.3 Register Day_alarm 14 48 | | | - | | |
| 8.6.3 Register Day_alarm 14 8.6.4 Register Weekday_alarm 14 8.6.5 Alarm flag 14 8.7 Register CLKOUT_ctrl and clock output 15 8.8 Timer function 16 8.8.1 Register Timer_ctrl 16 8.8.2 Register Timer 17 8.9 EXT_CLK test mode 17 8.9.1 Operation example 17 8.10 STOP bit function 18 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | | - | - | |
| 8.6.4 Register Weekday_alarm 14 8.6.5 Alarm flag 14 8.7 Register CLKOUT_ctrl and clock output 15 8.8 Timer function 16 8.8.1 Register Timer_ctrl 16 8.8.2 Register Timer 17 8.9 EXT_CLK test mode 17 8.9.1 Operation example 17 8.10 STOP bit function 18 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | - | 27 | Contents | 48 |
| 8.6.5 Alarm flag 14 8.7 Register CLKOUT_ctrl and clock output 15 8.8 Timer function 16 8.8.1 Register Timer_ctrl 16 8.8.2 Register Timer 17 8.9 EXT_CLK test mode 17 8.9.1 Operation example 17 8.10 STOP bit function 18 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | | | | |
| 8.7 Register CLKOUT_ctrl and clock output. 15 8.8 Timer function. 16 8.8.1 Register Timer_ctrl. 16 8.8.2 Register Timer. 17 8.9 EXT_CLK test mode. 17 8.9.1 Operation example. 17 8.10 STOP bit function. 18 8.11 Reset. 19 8.11.1 Power-On Reset (POR) override. 20 9 Characteristics of the I²C-bus. 21 9.1 Bit transfer. 21 9.2 START and STOP conditions. 21 | | | | | |
| 8.8 Timer function 16 8.8.1 Register Timer_ctrl 16 8.8.2 Register Timer 17 8.9 EXT_CLK test mode 17 8.9.1 Operation example 17 8.10 STOP bit function 18 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | | | | |
| 8.8.1 Register Timer_ctrl 16 8.8.2 Register Timer 17 8.9 EXT_CLK test mode 17 8.9.1 Operation example 17 8.10 STOP bit function 18 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | • | | | |
| 8.8.2 Register Timer 17 8.9 EXT_CLK test mode 17 8.9.1 Operation example 17 8.10 STOP bit function 18 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | | | | |
| 8.9 EXT_CLK test mode | | | | | |
| 8.9.1 Operation example 17 8.10 STOP bit function 18 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | | | | |
| 8.10 STOP bit function 18 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | | | | |
| 8.11 Reset 19 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | | | | |
| 8.11.1 Power-On Reset (POR) override 20 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | | | | |
| 9 Characteristics of the I²C-bus 21 9.1 Bit transfer 21 9.2 START and STOP conditions 21 | | | | | |
| 9.1 Bit transfer | | , , | | | |
| 9.2 START and STOP conditions | | | | | |
| | | | | | |
| | | | | | |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2013.

All rights reserved.

О компании

ООО "ТрейдЭлектроникс" - это оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов. Реализуемая нашей компанией продукция насчитывает более полумиллиона наименований.

Благодаря этому наша компания предлагает к поставке практически не ограниченный ассортимент компонентов как оптовыми, мелкооптовыми партиями, так и в розницу.

Наличие собственной эффективной системы логистики обеспечивает надежную поставку продукции по конкурентным ценам в точно указанные сроки.

Срок поставки со стоков в Европе и Америке – от 3 до 14 дней.

Срок поставки из Азии - от 10 дней.

Благодаря развитой сети поставщиков, помогаем в поиске и приобретении экзотичных или снятых с производства компонентов.

Предоставляем спец цены на элементы для создания инженерных сэмплов.

Упорный труд, качественный результат дают нам право быть уверенными в себе и надежными для наших клиентов.

Наша компания это:

- Гарантия качества поставляемой продукции
- Широкий ассортимент
- Минимальные сроки поставок
- Техническая поддержка
- Подбор комплектации
- Индивидуальный подход
- Гибкое ценообразование

Наша организация особенно сильна в поставках модулей, микросхем, пассивных компонентов, ксайленсах (XC), EPF, EPM и силовой электроники.

Большой выбор предлагаемой продукции, различные виды оплаты и доставки, позволят Вам сэкономить время и получить максимум выгоды от сотрудничества с нами!



<u>Перечень производителей, продукцию которых мы поставляем</u> на российский рынок

























































































































RENESAS



















гарантия бесперебойности производства и качества выпускаемой продукции

С удовольствием будем прорабатывать для Вас поставки всех необходимых компонентов по текущим запросам для скорейшего выявления групп элементов, по которым сотрудничество именно с нашей компанией будет для Вас максимально выгодным!

С уважением,
Менеджер отдела продаж ООО
«Трейд Электроникс»
Шишлаков Евгений
8 (495)668-30-28 доб 169
manager28@tradeelectronics.ru

http://www.tradeelectronics.ru/